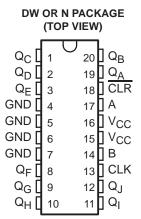
SCAS143 - OCTOBER 1990 - REVISED APRIL 1993

- AND-Gated (Enable/Disable) Serial Inputs
- Fully Buffered Clock and Serial Inputs
- Direct Clear
- Fully Synchronous Data Transfers
- Flow-Through Architecture Optimizes
 PCB Layout
- Center-Pin V_{CC} and GND Pin Configurations Minimize High-Speed Switching Noise
- EPIC[™] (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages and Standard Plastic 300-mil DIPs



description

The 74AC11898 features AND-gated serial inputs and an asynchronous clear. The gated serial inputs (A and B) permit complete control over incoming data. A low at either input inhibits entry of new data and resets the first flip-flop to the low level on the rising edge of the next clock pulse. A high-level input enables the other input, which then determines the state of the first flip-flop. Data at the serial inputs may be changed while the clock is high or low provided the minimum setup and hold time requirements are met. Clocking occurs on the low-to-high transition of the clock input.

The 74AC11898 is characterized for operation from -40°C to 85°C.

FUNCTION TABLE

INPUTS					OUTF	UTS	
CLR	CLK	Α	В	Q_{A}	Q_{B}		Q٦
L	Х	Χ	Х	L	L		L
Н	L	Χ	X	Q _{A0}	Q_{B0}		Q_{JO}
Н	\uparrow	Н	Н	Н	Q_{AN}		Q_{IN}
Н	\uparrow	L	X	L	Q_{AN}		Q_{IN}
Н	1	Χ	L	L	Q_{AN}		Q_{IN}

H = high level (steady state)

X = irrelevant (any input, including transitions)

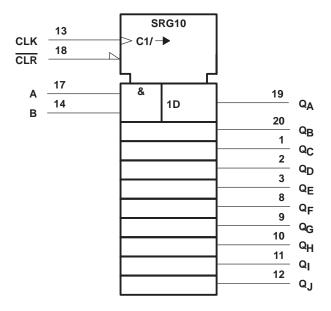
↑ = transition from low to high level

 $\rm Q_{AO},\, Q_{BO},\, Q_{JO}$ = the level of $\rm Q_{A},\, Q_{B},\, Q_{J}$ respectively, before the indicated steady-state input conditions were established.

 Q_n , Q_{in} = the level or Q_A or Q_J before the most recent \uparrow transition of the clock; indicates a one-bit shift.

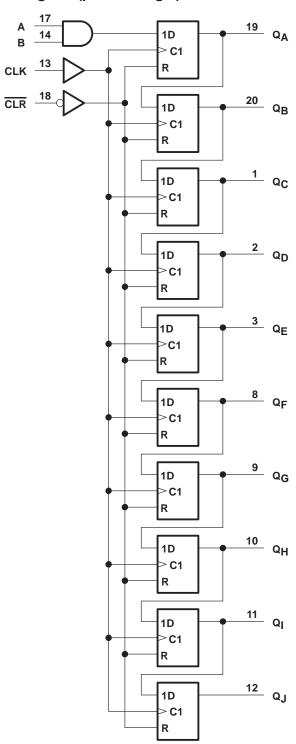
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logic symbol[†]



[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



74AC11898 10-BIT PARALLEL-OUT SERIAL SHIFT REGISTER

SCAS143 - OCTOBER 1990 - REVISED APRIL 1993

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	
Input voltage range, V _I (see Note 1)	\dots -0.5 V to V _{CC} + 0.5 V
Output voltage range, V _O (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through V _{CC} or GND	±250 mA
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 2)

			MIN	NOM	MAX	UNIT
VCC	Supply voltage		3	5	5.5	V
		V _{CC} = 3 V	2.1			
V_{IH}	High-level input voltage	$V_{CC} = 4.5 V$	3.15			V
		V _{CC} = 5.5 V	3.85			
		VCC = 3 V			0.9	
V_{IL}	Low-level input voltage	V _{CC} = 4.5 V			1.35	V
		V _{CC} = 5.5 V			1.65	
٧ _I	Input voltage		0		VCC	V
٧o	Output voltage		0		VCC	V
		VCC = 3 V		1.65 0 VCC 0 VCC -4 -24	-4	
loh	High-level output current	V _{CC} = 4.5 V			-24	mA
		$V_{CC} = 5.5 \text{ V}$			-24	
		V _{CC} = 3 V			12	
lOL	Low-level output current	$V_{CC} = 4.5 \text{ V}$			24	mA
		V _{CC} = 5.5 V			24	
Δt/Δν	Input transition rise or fall rate		0		10	ns/V
T _A	Operating free-air temperature		-40		85	°C

NOTE 2: Unused or floating inputs must be held high or low.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

SCAS143 - OCTOBER 1990 - REVISED APRIL 1993

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS	.,	TA = 25°C					
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	UNIT
			2.9			2.9		
	$I_{OH} = -50 \mu\text{A}$	4.5 V	4.4			4.4		
		5.5 V	5.4			5.4		
VOH	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		V
		4.5 V	3.94			3.8		
	$I_{OL} = -24 \text{ mA}$		4.94			4.8		
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85		
	ΙΟL = 50 μΑ	3 V			0.1		0.1	
		4.5 V			0.1		0.1	
		5.5 V			0.1		0.1	
VOL	I _{OL} = 12 mA	3 V			0.36		0.44	V
		4.5 V			0.36		0.44	
	I _{OL} = 24 mA				0.36		0.44	
	I _{OL} = 75 mA [†]	5.5 V					1.65	
Ц	V _I = V _{CC} or GND	5.5 V			±0.1		±1	μΑ
lcc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80	μΑ
Ci	$V_I = V_{CC}$ or GND	5 V		4				pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

	PARAMETER	T _A = 2	T _A = 25°C		MAX	UNIT	
	PARAMETER			MAX		MIN	UNII
fclock	Clock frequency		0	40	0	40	ns
	Dulas dematics	CLR low	5		5		ns
t _W	Pulse duration	CLK high or low	12.5		12.5		
		Data	14		14		
tsu	Setup time before CLK↑	CLR inactive	1.5		1.5		ns
t _h	Hold time, data after CLK↑		0		0		ns

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

	DADAMETED	T _A =	T _A = 25°C		MAX	UNIT	
	PARAMETER				MIN	WAX	UNIT
fclock	Clock frequency		0	60	0	60	ns
		CLR low	4.5		4.5		ns
t _W	Pulse duration	CLK high or low	8.3		8.3		
	Octor than before OLKA	Data	8.5		8.5		
t _{su}	Setup time before CLK↑	CLR inactive	1.5		1.5		ns
th	Hold time, data after CLK↑		0		0		ns

74AC11898 10-BIT PARALLEL-OUT SERIAL SHIFT REGISTER

SCAS143 - OCTOBER 1990 - REVISED APRIL 1993

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

242445752	FROM	то	T _A = 25°C					
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN MAX	MAX	UNIT
f _{max}			40	60		40		MHz
^t PHL	CLR	Any Q	4.1	9.4	11.7	4.1	13	ns
t _{PLH}	CLK Any Q	3.3	8.2	10.7	3.3	11.9	20	
^t PHL		Ally Q	3.9	8.9	10.8	3.9	12.2	ns

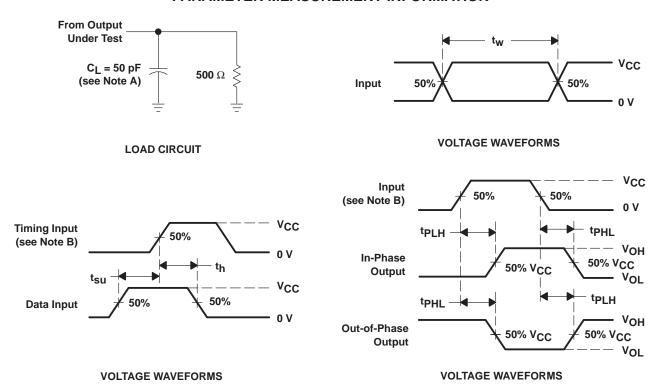
switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	T _A = 25°C				MAY	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN M	MAX	UNIT
fmax			60	90		60		MHz
t _{PHL}	CLR	Any Q	3.8	6.7	9.1	3.8	10.3	ns
^t PLH	CLK	Any O	2.7	5.5	7.9	2.7	8.1	20
t _{PHL}	OLK	Any Q	3.1	6.3	8.6	3.1	10	ns

operating characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	$C_L = 50 \text{ pF}, \qquad f = 1 \text{ MHz}$	122	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. CL includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_{O} = 50 \Omega$, $t_{f} = 3 \text{ ns}$, $t_{f} = 3 \text{ ns}$.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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